Application No. 10/624,003 Amendment dated Jan. 10, 2005 Reply to Office Action of Dec. 01, 2004

Amendment to the Claims:

This listing of Claims will replace all prior versions, listings of Claims in the application:

Listing of Claims:

1. [1] (currently amended) A non-vacuum process for the fabrication of an electronic and

opto-electronic device based on organic semiconductors[[,]] said electronic and opto-

electronic device comprising a first electrode layer; at least one organic semiconductor

material layer; and a second electrode layer comprising the steps of:

forming a first electrode layer using non-vacuum processing techniques;

- forming at least one organic semiconductor material layer using non-

vacuum processing techniques; and

- forming a second electrode layer using non-vacuum processing techniques.

2. (canceled)

3. [3] (currently amended) A non-vacuum process as defined in Claim 1 wherein methods

for fabrication of said non-vacuum processing techniques for forming said first electrode

layer and said second electrode layer are independently selected from a group of

electrochemical processing techniques [[of]] including electroless deposition and

electrodeposition. Said electroless deposition and electrodeposition may be carried out in

either aqueous phase or organic phase.

3

4. [4] (currently amended) A non-vacuum process as defined in Claim 1 wherein methods

for fabrication of said non-vacuum processing techniques for forming said first electrode

layer and said second electrode layer are independently selected from a group of solution

processing techniques [[of]] including spin coating, ink-jet-printing[[,]] thermal transfer

printing, spray and screen printing.

5. [5] (currently amended) A non-vacuum process as defined in Claim 1, wherein said

first electrode layer is selected from a group of materials with low work functions,

whereas said second electrode layer is selected from a group of materials with high work

functions.

6. [6] (currently amended) A non-vacuum process as defined in Claim 1, wherein

deposition of said first and second electrode layers are performed in a chamber containing

an inert gas and a reduction agent.

7. [7] (currently amended) A non-vacuum process as defined in Claim 1, further

comprising a step of treating said electrode layers in a reducing atmosphere in order to

minimize contents of oxygen and water.

8. [8] (currently amended) A non-vacuum process as defined in Claim 1 wherein methods

for application said non-vacuum processing techniques for forming said organic

semiconductor layer are selected from a group of solution processing techniques of spin

coating, screen printing, ink jet printing, thermal transfer printing, and others spray and

dip-coating.

9. (cancelled)

4

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10. [10] (currently amended) A non-vacuum process as defined in Claim 1 further comprising a step of forming said device in a "layer to layer" mode by combining a first part and a second part. Said first part consisting of the first electrode coated with at least a

layer of a first organic semiconductor material, said second part consisting of the second

electrode coated with at least a layer of a second organic semiconductor material. Said

first part and second part being constructed separately and assembled by aligning and

sticking said first part onto said second part. And sticking of said first part to second part

is achieved by cross-linking said first organic semiconductor layer and said second

organic semiconductor layer with assistance of heating, light or electron radiation.

11. [44] (currently amended) A non-vacuum process as defined in Claim 1, wherein said organic electronic and opto-electronic device being selected from a group of: organic

light emitting diode, organic thin film transistor, organic solar cell, organic photodiode,

organic memory chip, organic electronic circuit, and organic sensor.